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Part Number: 0740401344

Status: Active

Overview: VHDM Backplane Connector Systems

Description: VHDM Daughtercard, 2.00mm Pitch, 8-Rows, 45 Wafers, 360 Circuits, Tin Lead, Guide

Module

**Documents:** 

Drawing (PDF) RoHS Certificate of Compliance (PDF)

Packaging Specification PK-70873-5041-001 (PDF)

**Agency Certification** 

UL E29179

General

Product Family Backplane Connectors

Series <u>74040</u>
Application Backplane
Application Tooling Documents TM-622010999

Comments Daughter Card, Daughter Card

Component Type PCB Header

Overview VHDM Backplane Connector Systems

Product Name VHDM

UPC 883906551834

**Physical** 

Circuits (Loaded) 360 Circuits (maximum) 360 Color - Resin Black Durability (mating cycles max) 200 First Mate / Last Break No Flammability 94V-0 **Guide to Mating Part** Yes Keying to Mating Part N/A Copper Alloy Material - Metal

Material - Metal Copper Alic Material - Plating Mating Gold Material - Plating Termination Matte Tin

Material - Resin High Performance Thermoplastic

Net Weight99.440/gNumber of Columns45Number of PairsN/ANumber of Rows8OrientationRight Angle

PC Tail Length 2.80mm PCB Locator No **PCB** Retention None PCB Thickness - Recommended 1.80mm Packaging Type Tube Pitch - Mating Interface 2.00mm Plating min - Mating 0.762µm Polarized to PCB No

Stackable Yes
Surface Mount Compatible (SMC) Yes

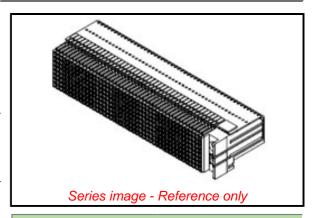
Termination Interface: Style Through Hole - Compliant Pin

-55° to +80°C

**Electrical** 

Temperature Range - Operating

Current - Maximum per Contact 1.0A



**EU ELV** 

**Not Relevant** 

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -ED/71/2019 (16 July 2019)

Halogen-Free

<u>Status</u>

Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

**Search Parts in this Series** 

74040 Series

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

**Description** Product # Single Wafer 621004300

Removal Tool

Card Stiffener 622016200

Removal Tool

Insertion Module 622020214

Data Rate 3.125 Gbps

Shielded Yes

Voltage - Maximum 120V AC (RMS)/DC

**Solder Process Data** 

Lead-freeProcess Capability N/A

**Material Info** 

**Reference - Drawing Numbers** 

Packaging Specification PK-70873-5041-001 Sales Drawing SD-74040-1344

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